APPLICA	BLE STAND	ARD									
	OPERATING TEMPERATURE RANGE		−55°C TO +85°C	STORAGE TEMPERATURE RANG		GE	-10°C TO +50°C(PACKED CONDITON)				
RATING	VOLTAGE		30V AC/DC		PERATING OR STORAGI JMIDITY RANGE		RELATIVE HUMIDITY 90%MAX(NOT DE				)
	CURRENT		0.2A	APPLICABLE CABLE		t=0.2±0.03mm, GOLD PLATING					
			SPE	CIFICA	ATION	IS					
Г	TEM		TEST METHOD					REQL	JIREMENTS	QT	АТ
CONSTR	UCTION	•									
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.				×	×
MARKING		CONFIRMED VISUALLY.				-			×	×	
ELECTRI	C CHARAC	TERIST	ICS							1	
VOLTAGE P	ROOF	90V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.				×	×	
INSULATION	RESISTANCE	100V DC.				50MΩ MIN.				×	×
CONTACT R	RESISTANCE	AC 20mV MAX (1KHz), 1mA.				100mΩ MAX.				×	×
						INCLUDING FPC BULK RESISTANCE (L=12mm)					
MECHAN	ICAL CHAF	RACTER	ISTICS								
VIBRATION		FREQUENCY 10 TO 55 Hz, HALF AMPLITUDE				$\bigcirc$ NO ELECTRICAL DISCONTINUITY OF 1 $\mu$ s.				×	_
SHOCK	SHOCK		0.75 mm FOR 10 CYCLES IN 3 DIRECTIONS.  981 m/s², DURATION OF PULSE 6ms AT 3 TIMES			② CONTACT RESISTANCE: 100mΩ MAX. ③ NO DAMAGE, CRACK AND LOOSENESS			×	_	
MECHANICA	L OPERATION	IN 3 DIRECTIONS.  10 TIMES INSERTIONS AND EXTRACTIONS.				OF PARTS.  (1) CONTACT RESISTANCE: 100m Ω MAX.			' '		
MEGINATION IN		TO THIS INSERTIONS AND EXTINIONS.				② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.			×	_	
	TION FORCE	MEASURED BY APPLICABLE FPC.				DIRECTION OF INSERTION: 0.15 N×n MIN. (note 1)			×	_	
<u> </u>		(THICKNESS OF FPC SHALL BE t=0.20mm AT INITIAL CONDITION.)				(note 1)					
ENVIRON	IMENTAL C	HARAC	TERISTICS								
		EXPOSED AT 35±2°C, 5% SALT WATER SPRAY FOR 96h.			ΛY	<ol> <li>CONTACT RESISTANCE: 100mΩ MAX.</li> <li>NO DAMAGE, CRACK AND LOOSENESS</li> </ol>				×	-
						OF PARTS.  ③ NO EVIDENCE OF CORROSION WHICH					
						AFFECTS TO OPERATION OF CONNECTOR.					
RAPID CHANGE OF		TEMPERATURE $-55 \rightarrow +15$ TO $+35 \rightarrow +85 \rightarrow +15$ TO $+35 \circ$ C TIME $30 \rightarrow 2 \sim 3 \rightarrow 30 \rightarrow 2 \sim 3$ min				① CONTACT RESISTANCE: 100m Ω MAX. ② INSULATION RESISTANCE: 50M Ω MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	_
TEMPERATURE		UNDER 5 CYCLES. $30 \rightarrow 2 \sim 3 \rightarrow 30 \rightarrow 2 \sim 3 \text{ min}$			ın						
DAMP HEAT		EXPOSED AT 40±2°C, RELATIVE HUMIDITY 90 TO 95% 96h.								×	_
(STEADY STATE)		RELATIVE HUMIDITY 90 TO 95%, 96h.									
COUN	IT C	DESCRIPTION OF REVISIONS		DESIG	ESIGNED		CHECKED		DA	DATE	
1		DIS-F-003534		SJ.WA	SJ.WADA		HS.SAKAMOTO		08.1	08.11.20	
REMARK							APPRO	VED	RI.TAKAYASU	06.1	1.20
							CHECK		RI.TAKAYASU	06.1	
Unless otherwise enecified refer to US C 5400			. I. IIC O E400				DESIGN		HS.HIRAHARA	06.1	
Unless otherwise specified, refer to JIS C 5402.						DRAV	VIV	HS.HIRAHARA	06.1	1.20	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DRAWING NO. ELC4-15664						
		SPECIFICATION SHEET				PART NO.		FH26G-67S-0.3SHBW(0			
HII		ROSE ELECTRIC CO., LTD.		CODE NO.		CL580-1701-0-05			<u> </u>	1/2	

	SPECIFICATIO	NS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
DAMP HEAT, CYCLIC	EXPOSED AT -10 TO +65 °C RELATIVE HUMIDITY 90 TO 96 % 10 CYCLES, TOTAL 240h.	CONTACT RESISTANCE: 100m Ω MAX.     INSULATION RESISTANCE: 1M Ω MIN.     (AT HIGH HUMIDITY)     INSULATION RESISTANCE: 50M Ω MIN.     (AT DRY)     NO DAMAGE, CRACK AND LOOSENESS     OF PARTS.	×	_
DRY HEAT	EXPOSED AT 85±2°C, 96h.	① CONTACT RESISTANCE: 100m Ω MAX. ② NO DAMAGE, CRACK AND LOOSENESS		-
COLD	EXPOSED AT -55±3°C, 96h.	OF PARTS.	×	-
SURPHUR DIOXIDE [JIS C 0090]	EXPOSED AT 40±2°C, RELATIVE HUMIDITY 80±5 %, 25±5 PPM FOR 96h.	CONTACT RESISTANCE: 100mΩ MAX.     NO DAMAGE, CRACK AND LOOSENESS     OF PARTS.	×	_
HYDROGEN SULPHIDE [JIS C 0092]	EXPOSED AT 40±2°C, RELATIVE HUMIDITY 80±5 %, 10 ~ 15 PPM FOR 96h.	③ NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR.	×	-
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, $235\pm5^{\circ}\text{C}$ FOR IMMERSION DURATION, $2\pm0.5~\text{sec.}$	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	×	_
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING: PEAK TMP. 250°CMAX. REFLOW TMP. 230°C MIN FOR 60 sec. 2) SOLDERING IRONS: TMP. 350±10°C FOR 5±1 sec.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS. (note 2)	×	_

## (note 1)

THIS PRODUCT HAS FLIP-LOCK CONSTRUCTION. FASTEN FPC ON PCB OR SOMETHING FIXED IF FORCE IN VERTICAL DIRECTION SHALL BE PREDICTED.

## (note 2)

BLISTERS WHICH MAY OCCUR IN HOUSING DO NOT AFFECT PRODUCT PERFORMANCE.

Note QT:Qu	alification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-156646-01		
HRS	SPECIFICATION SHEET	PART NO.	FH26G-67S-0.3SHBW(0			
1	HIROSE ELECTRIC CO., LTD.	CODE NO	CL580	) <del>-1701-0-05</del>	Â	2/2